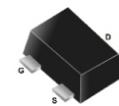


CMSP3139K-HF

P-Channel
RoHS Device
Halogen Free



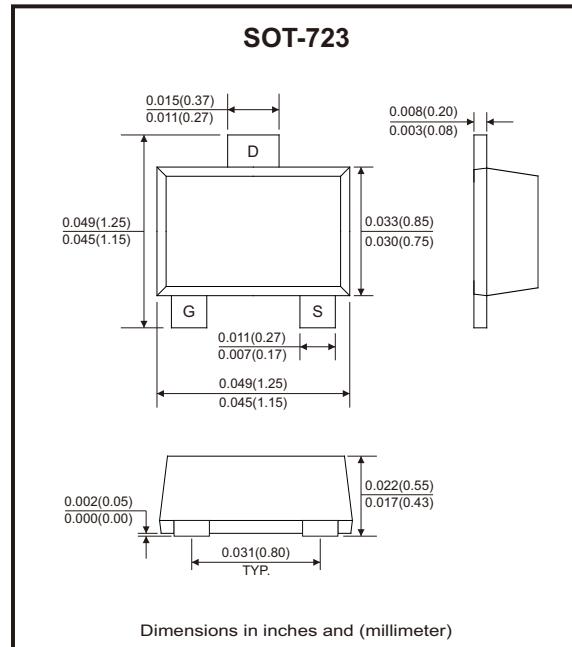
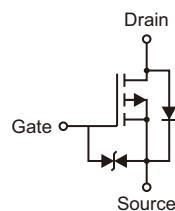
Features

- Extremely low switching loss.
- Excellent stability and uniformity.

Mechanical data

- Case: SOT-723, molded plastic.
- Mounting position: Any.

Circuit Diagram



Maximum Ratings (at $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	-20	V
Gate-source voltage	V_{GS}	± 10	V
Drain current	I_D	-0.5	A
		-0.3	
Pulsed drain current (Note 1)	I_{DM}	-2.5	A
Total power dissipation (Note 2)	P_D	0.28	W
		0.1	
Junction and storage temperature range	T_J, T_{STG}	-55 to +150	°C

Thermal resistance

Parameter	Symbol	Typ	Max	Unit
Thermal resistance junction to ambient (Note 3)	$R_{\theta JA}$	350	450	°C/W

Notes: 1. Pulse width limited by max. junction temperature.

2. PD is based on max. junction temperature, using junction case and junction ambient thermal resistance.

3. The value of $R_{\theta JA}$ is measured with the device mounted on the minimum recommend pad size, in the still air environment with $TA=25^\circ\text{C}$. The maximum allowed junction temperature of 150°C . The value in any given application depends on the user's specific board design.

Electrical Characteristics (at $T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Static Parameters						
Drain-source breakdown voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = -250\mu\text{A}$	-20			V
Zero gate voltage drain current	$I_{\text{DS}}^{\text{SS}}$	$V_{\text{DS}} = -20\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
		$V_{\text{DS}} = -20\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 150^\circ\text{C}$			-100	
Gate-body leakage current	I_{GSS}	$V_{\text{GS}} = \pm 10\text{V}, V_{\text{DS}} = 0\text{V}$			± 10	μA
Gate threshold voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = -250\mu\text{A}$	-0.35	-0.7	-1.1	V
Static drain-source on-resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -0.5\text{A}$		650	850	$\text{m}\Omega$
		$V_{\text{GS}} = -2.5\text{V}, I_{\text{D}} = -0.3\text{A}$		900	1200	
		$V_{\text{GS}} = -1.8\text{V}, I_{\text{D}} = -0.2\text{A}$		1400	2000	
Diode forward voltage	V_{SD}	$I_{\text{S}} = -0.5\text{A}, V_{\text{GS}} = 0\text{V}$		-0.95	-1.2	V
Max. body-diode continuous current	I_{S}				-0.5	A
Dynamic Parameters						
Input capacitance	C_{iss}	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		40		pF
Output capacitance	C_{oss}			15		
Reverse transfer capacitance	C_{rss}			10		
Switching Parameters						
Total gate charge	Q_{g}	$V_{\text{GS}} = -4.5\text{V}, V_{\text{DS}} = -10\text{V}, I_{\text{D}} = -0.5\text{A}$		1.24		nC
Gate-source charge	Q_{gs}			0.37		
Gate-drain charge	Q_{gd}			0.27		
Reverse recovery charge	Q_{rr}			0.97		
Reverse recovery time	t_{rr}	$I_{\text{F}} = -0.5\text{A}, di / dt = 100\text{A}/\mu\text{s}$ $V_{\text{GS}} = -4.5\text{V}, V_{\text{DD}} = -10\text{V}, I_{\text{D}} = -0.5\text{A}, R_{\text{GEN}} = 3\Omega$		26		ns
Turn-on delay time	$t_{\text{d(on)}}$			4		
Turn-on rise time	t_{r}			19		
Turn-off delay time	$t_{\text{d(off)}}$			16		
Turn-off fall time	t_{f}			25		

Typical Rating and Characteristic Curves (CMSP3139K-HF)

Fig.1 - Output Characteristics

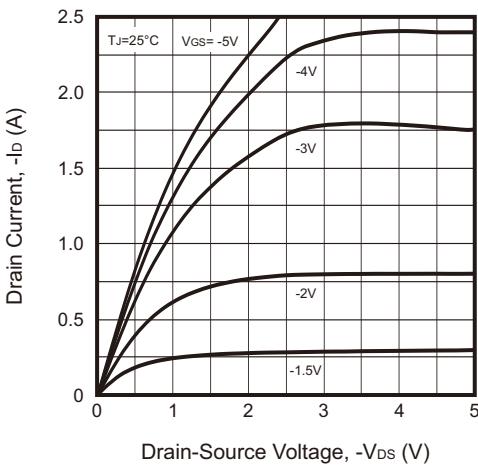


Fig.2 - Transfer Characteristics

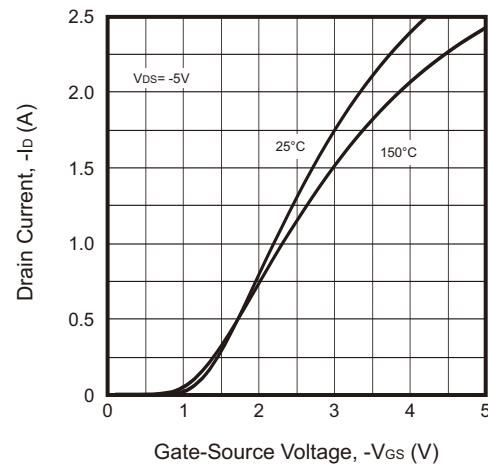


Fig.3 - Capacitance Characteristics

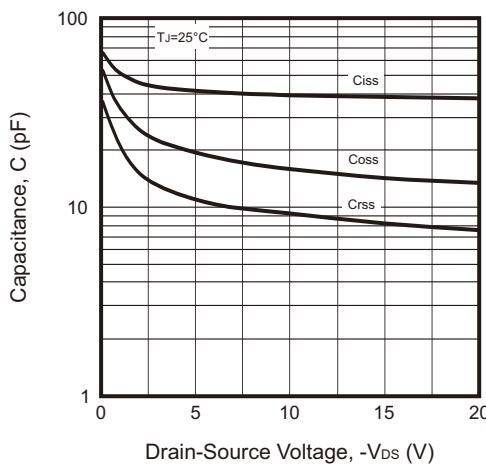


Fig.4 - Gate Charge

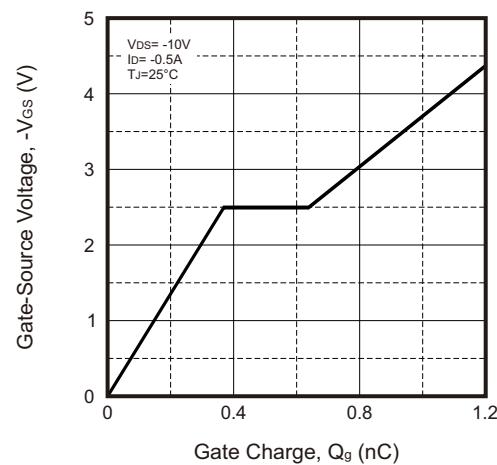


Fig.5 - On Resistance vs Gate to Source Voltage

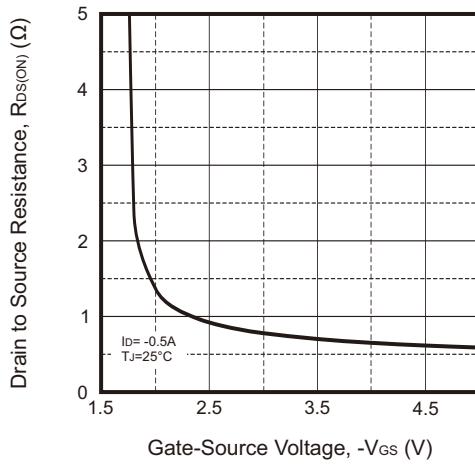
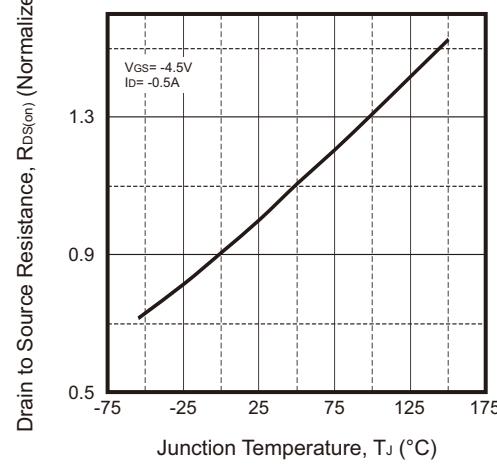


Fig.6 - Normalized on Resistance



Typical Rating and Characteristic Curves (CMSP3139K-HF)

Fig.7 - $R_{DS(on)}$ vs Drain Current

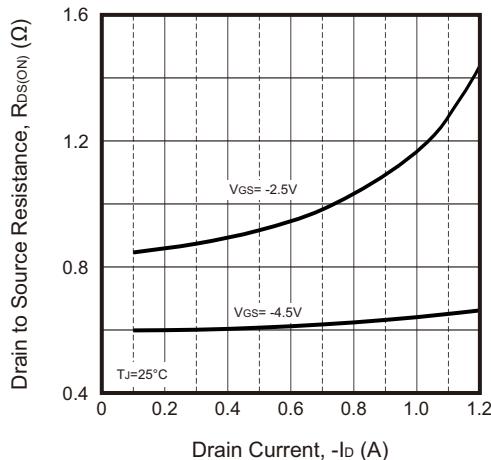


Fig.8 - Forward Characteristics of Reverse Diode

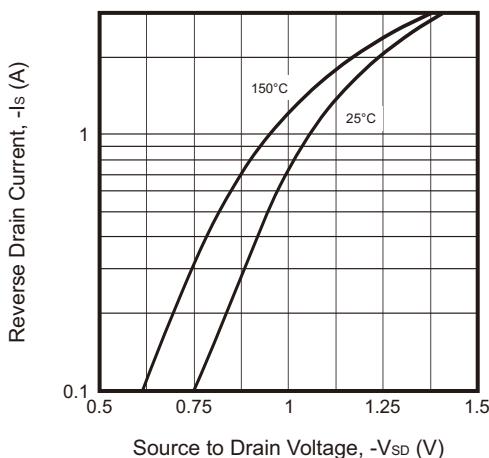


Fig.9 - Normalized Breakdown Voltage

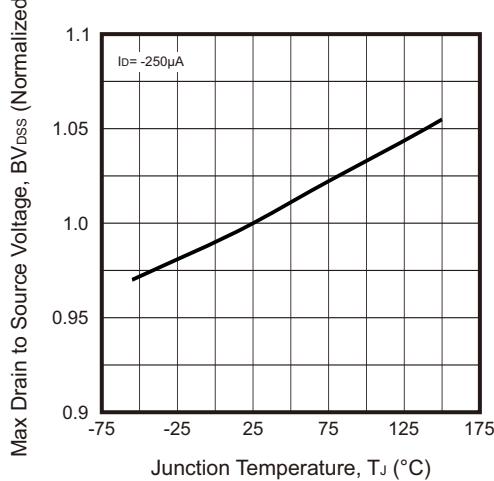


Fig.10 - Normalized Threshold Voltage

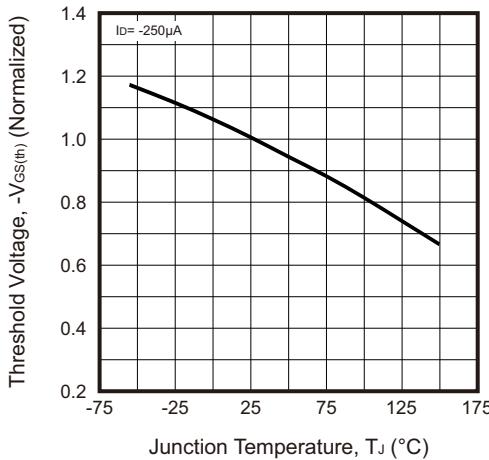


Fig.11 - Current Dissipation

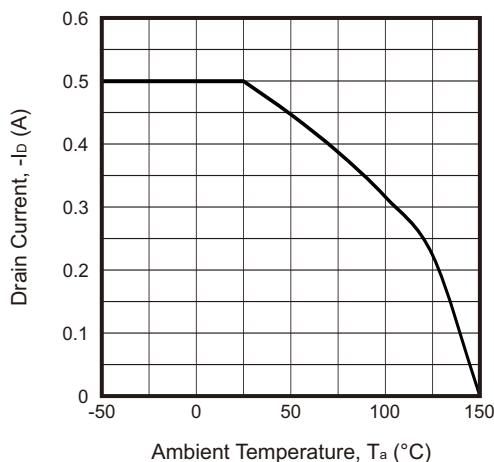
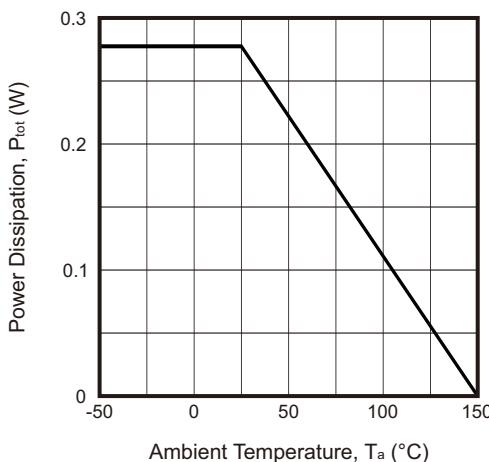
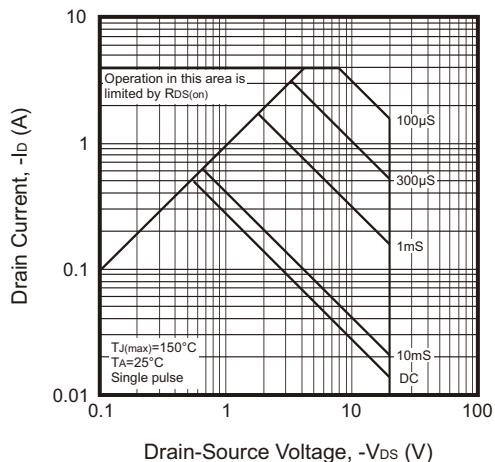


Fig.12 - Power Dissipation

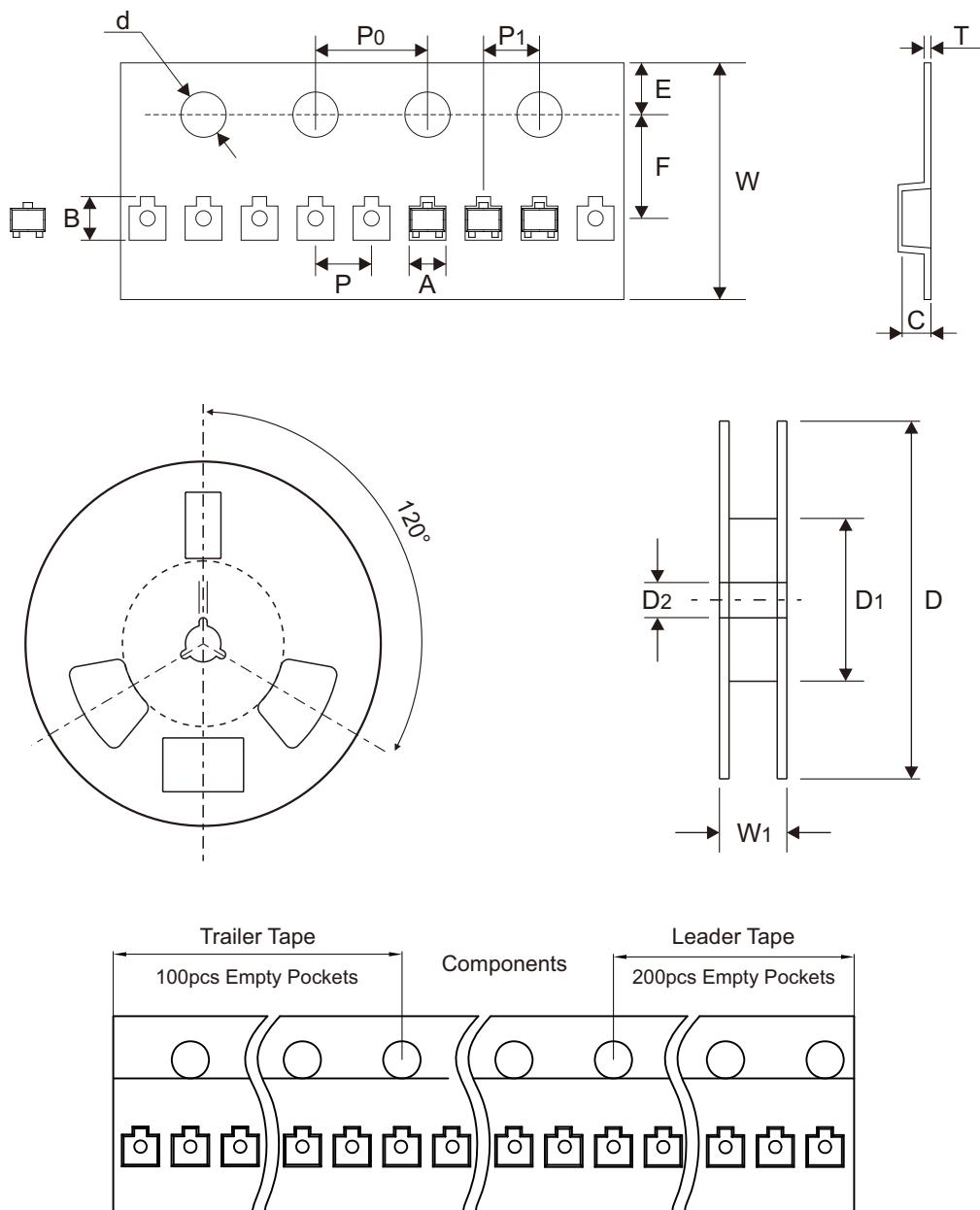


Typical Rating and Characteristic Curves (CMSP3139K-HF)

Fig.13 - Safe Operation Area



Reel Taping Specification

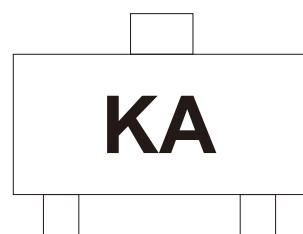


SOT-723	SYMBOL	A	B	C	d	D	D1	D2
	(mm)	1.38 ± 0.05	1.40 ± 0.05	0.60 ± 0.05	$1.50 + 0.10$	178.00 ± 2.00	54.40 ± 1.00	13.00 ± 1.00
	(inch)	0.054 ± 0.002	0.055 ± 0.002	0.024 ± 0.002	$0.059 + 0.004$	7.008 ± 0.079	2.142 ± 0.039	0.512 ± 0.039

SOT-723	SYMBOL	E	F	P	P0	P1	T	W	W1
	(mm)	1.75 ± 0.10	3.50 ± 0.05	2.00 ± 0.05	4.00 ± 0.10	2.00 ± 0.05	0.20 ± 0.02	$8.00 + 0.30 - 0.10$	12.30 ± 1.00
	(inch)	0.069 ± 0.004	0.138 ± 0.002	0.079 ± 0.002	0.157 ± 0.004	0.079 ± 0.002	0.008 ± 0.001	$0.315 + 0.012 - 0.004$	0.484 ± 0.039

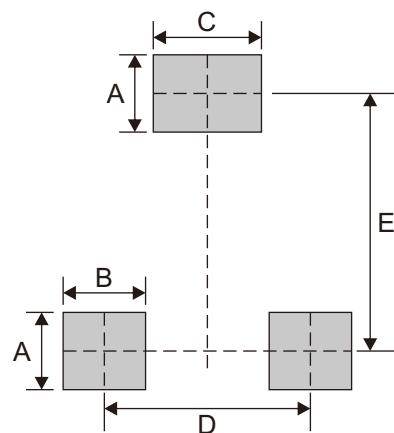
Marking Code

Part Number	Marking Code
CMSP3139K-HF	KA



Suggested P.C.B. PAD Layout

SIZE	SOT-723	
	(mm)	(inch)
A	0.30	0.012
B	0.32	0.013
C	0.42	0.017
D	0.80	0.031
E	1.00	0.039



Standard Packaging

Case Type	REEL PACK	
	REEL (pcs)	Reel Size (inch)
SOT-723	8,000	7